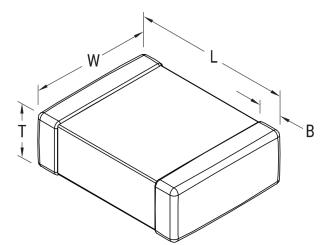


CBR04C339BAGAC

CBR-SMD RF COG, Ceramic, 3.3 pF, +/-0.1 pF, 250 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



Click here for the 3D model.

Dimensions		
Chip Size	0402	
L	1mm +/-0.05mm	
W	0.5mm +/-0.05mm	
Т	0.5mm +/-0.05mm	
В	0.25mm +0.05/-0.1mm	

Packaging Specifications		
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	10000	

General Information			
Series	CBR-SMD RF COG		
Style	SMD Chip		
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I		
Features	Ultra High Q, Low ESR, Class I		
RoHS	Yes		
Termination	Tin		
Marking	No		
AEC-Q200	No		
Notes	Solder Wave or Solder Reflow.		
Shelf Life	78 Weeks		
MSL	1		

Specifications				
Capacitance	3.3 pF			
Capacitance Tolerance	+/-0.1 pF			
Voltage DC	250 VDC			
Dielectric Withstanding Voltage	625 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	COG			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms			
Dissipation Factor	0.2%1MHz 1.0Vrms			
Aging Rate	0% Loss/Decade Hour			
Insulation Resistance	10 GOhms			
Quality Factor	466			

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)